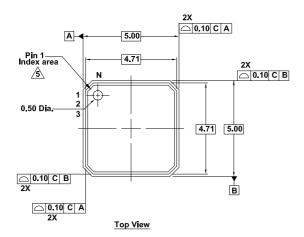
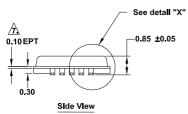
Plastic Packages for Integrated Circuits

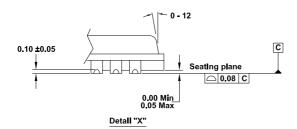
Package Outline Drawing

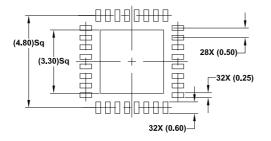
L32.5x5H

32 Lead Quad Flat No-Lead Plastic Package (Punch QFN with Wettable Flank) Rev 3, 8/2021

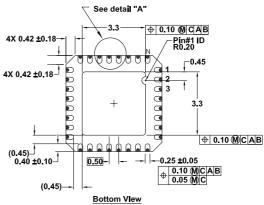


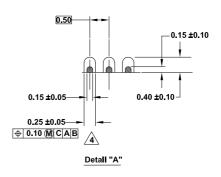






Typical Recommended Land Pattern





Notes:

- 1. Dimensions are in millimeters.
 - Dimensions in () for Reference Only.
- 2. Dimensioning and tolerancing conform to ASME 14.5m-1994.
- 3. Unless otherwise specified, tolerance: Decimal ±0.05
- Dimension applies to the plated terminal and is measured between 0.15mm and 0.30mm from the terminal tip.
- The configuration of the pin #1 Identifier is optional, but must be located within the zone indicated. The pin #1 identifier may be either a mold or mark feature.
- 6. Reference document: JEDEC MO220
- A Edge Protection Technology